AIDW16S65C5

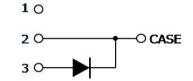


650V/16A Silicon Carbide Schottky Diode in TO247-3

Features

- Revolutionary semiconductor material Silicon Carbide
- Benchmark switching behavior
- No reverse recovery/ No forward recovery
- Temperature independent switching behavior
- High surge current capability
- Pb-free lead plating; RoHS compliant
- Junction Temperature range from -40°C to 175°C
- System efficiency improvement over Si diodes
- System cost / size savings due to reduced cooling requirements
- Enabling higher frequency / increased power density solutions
- Higher system reliability due to lower operating temperatures
- Reduced EMI





RoHS

Infineon

Potential Applications

- Traction inverter
- Booster / DCDC Converter
- On board Charger / PFC

Product Validation

"Qualified for Automotive Applications. Product Validation according to AEC-Q100/101"

Description

The 5th Generation CoolSiC[™] Automotive Schottky Diode represents Infineon leading edge technology for Silicon Carbide Schottky Barrier diodes. Thanks to a compact design and a technology based on thin wafers, this family of products shows improved efficiency over all load conditions resulting from both its thermal characteristics and low figure of merit (Qc x Vf). This product family has been designed to complement Infineon's IGBT and CoolMOS[™] portfolio. This ensures meeting the most stringent application requirements in the 650V voltage class.

🔁 Green

Product Information				
Ordering Code	AIDW16S65C5			
Marking	AD1665C5			
Package	PG-TO247-3-41			
SP Number	SP001725218			

Parameter	Value/Unit				
V _{DC,max}	650 V				
I _F ; T _C < 129 °C	16 A				
$Q_{\rm C}; V_{\rm R}$ = 400 V	23 nC				
$E_{C}; V_{R} = 400 V$	5.4 μJ				
T _{j,max}	175 °C				

Pin	Definition
Pin 2, case	Cathode
Pin 3	Anode



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Maximum Ratings

1 Maximum Ratings

Table 1Maximum ratings1

Parameter	Symbol	Value	Unit
Repetitive peak reverse voltage	V _{RRM}	650	V
Continuous forward current for $R_{thJC,max}$ T _c = 129 °C, D=1	I _F	16	А
Surge non-repetitive forward current, sine halfwave $T_c=25$ °C, $t_p=10$ ms $T_c=150$ °C, $t_p=10$ ms	I _{F,SM}	95 74	A
Non-repetitive peak forward current T _c = 25°C, t _p =10μs	l _{F,max}	637	A
$i^{2}t$ value T _c = 25°C, t _p =10ms T _c = 150°C, t _p =10ms	∫i ² dt	45 28	A ² s
Diode dv/dt ruggedness V _R =0480V	dv/dt	100	V/ns
Power dissipation T _c = 25°C	P _{tot}	94	W
Operating temperature	Tj	-40175	°C
Storage temperature	T _{stg}	-55150	°C
ESD Human body model, R= 1.5 kΩ, C = 100 pF Charged device model		8 2	kV
Soldering temperature, wavesoldering only allowed at leads, 1.6mm (0.063 in.) from case for 10 s	T _{sold}	260	°C
Mounting Torque (M3 and M4 screws)		70	Ncm



Thermal Characteristics

2 Thermal Characteristics

Table 2Thermal Characteristics1

Darameter	Symbol	Values			11	Noto /Toot oon dition
Parameter		Min.	Тур.	Max.	Unit	Note/Test condition
Thermal resistance, junction–case ²	R_{thJC}	-	1.2	1.6	K/W	
Thermal resistance, junction-ambient ²	R_{thJA}	-	I	62	K/W	



Electrical Characteristics

3 Electrical Characteristics

Table 3Static Characteristics

Parameter	Symbol	Values			Unit	Noto /Tost condition
Parameter		Min.	Тур.	Max.	Unit	Note/Test condition
DC blocking voltage	V _{DC}	650	-	-		T _j = 25°C, I _R = 0.09 mA
Diode forward voltage ³	V _F	-	1.5	1.7	v	T _j = 25°C, I _F = 16 A
		-	1.8	2.1		T _j = 150°C, I _F = 16 A
Reverse current	I _R	-	3	90		V _R = 650 V, T _j = 25 °C
		-	19	-	μA	V _R = 650 V, T _j = 150 °C

Table 4Dynamic Characteristics at Tj=25°C unless noted otherwise

Parameter	Symbol	Values			Unit	Noto/Tost condition
Parameter		Min.	Тур.	Max.	Unit	Note/Test condition
Total capacitive charge	Qc	-	23	-	nC	$V_R = 400 V, di/dt = 200 A/\mu s,$ $I_F \le I_{F,MAX}, T_j = 150 °C$
		-	471	-		V _R = 1 V, f = 1 MHz
Total capacitance	С	-	61	-	·	V _R = 300 V, f= 1 MHz
		-	60	-		V _R = 600 V, f= 1 MHz

Footnotes:

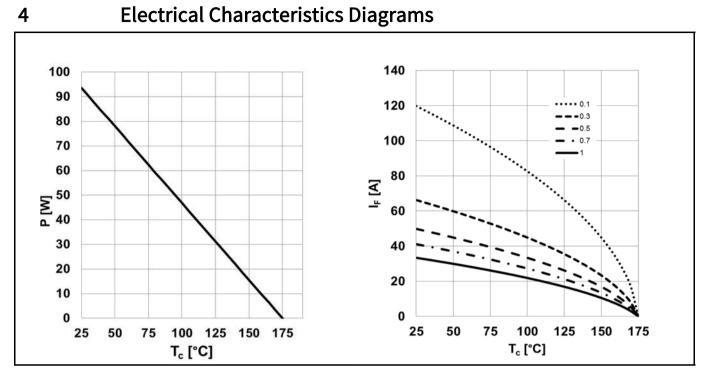
¹ The parameter is not subject to production test- verified by design/characterization.

² Rth,JC defined as per JESD-51-14. Rth,JA defined as per JESD-51-2.

³ Only the value at 25°C is subject to production test. The value at 150°C is only verified by design/characterization.

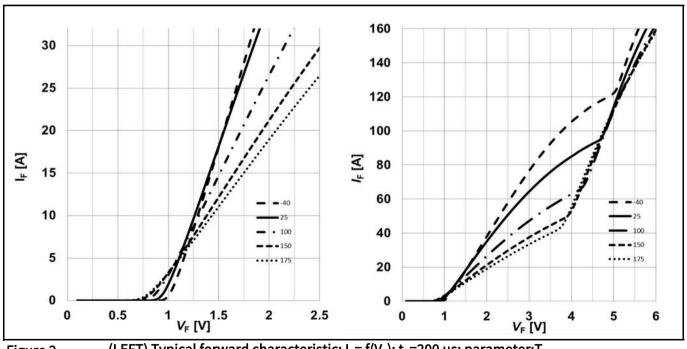


Electrical Characteristics Diagrams





(LEFT) Power dissipation; $P_{tot} = f(T_C)$; $R_{thJC,max}$ (RIGHT) Diode forward current; $I_F = f(T_C)$; $T_J \le 175$ °C; $R_{thJC,max}$; parameter: D=duty cycle







Electrical Characteristics Diagrams

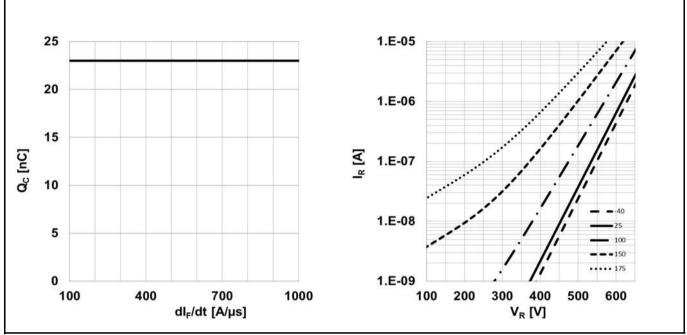
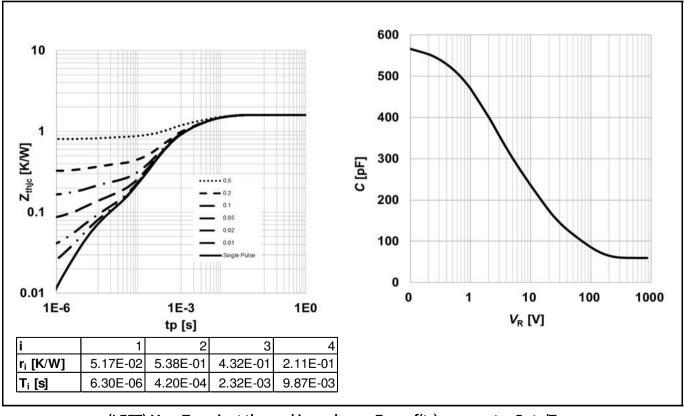


Figure 3(LEFT) Typical capacitive charge versus current slope (only capacitive charge, guaranteed
by design); $Q_c = f(di_F/dt)$; $T_j = 150^{\circ}C$; $V_R = 400V$; $I_F \le I_{F,max}$
(RIGHT) Typical reverse current versus reverse voltage; $I_R = f(V_R)$; parameter: T_i





(LEFT) Max. Transient thermal impedance; $Z_{thJC} = f(t_P)$; parameter:D= t_P/T (RIGHT) Typ. Capacitance vs. Reverse voltage; C= $f(V_R)$; $T_i = 25^{\circ}$ C; f=1 MHz



Electrical Characteristics Diagrams

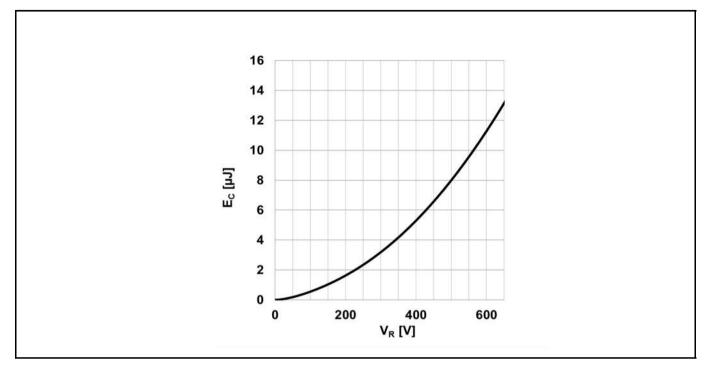
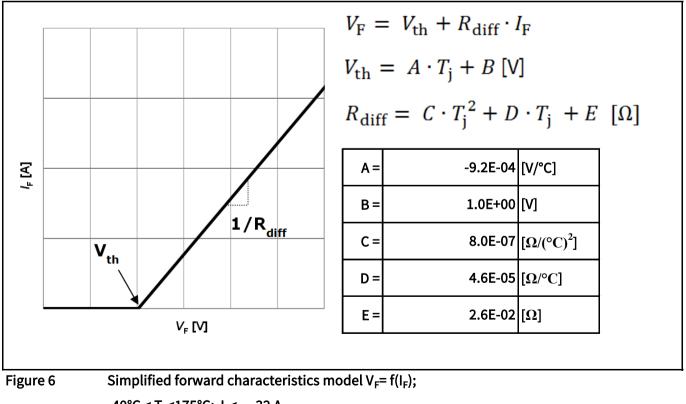


Figure 5 Typical capacitance stored energy; $E_{c} = f(V_{R})$



-40°C < T_j <175°C; I_F < 32 A



Package Outlines

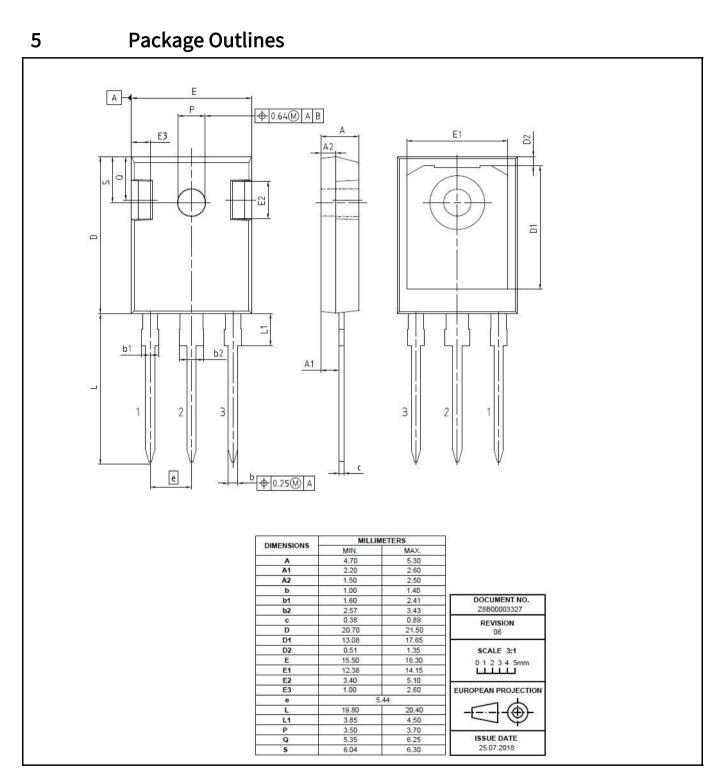


Figure 6

Package outline of PG-TO247-3-41 leaded (Dimensions in mm)



Revision History

Revision History

Document Version	Date of Release	Description of changes			
V3.0	26.11.2018	1st release of Data Sheet			



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